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Dated: November 3, 2004 Signature:

Docket No. 27702/10065 (PATENT)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of: Gary Wentworth et al.

Application No.: 10/706,196

Filed: November 12, 2003

For: ADHESION PROMOTERS FOR CORD-

REINFORCED THERMOPLASTIC POLYMERIC MATERIALS AND SUBSTRATE/THERMOPLASTIC

POLYMERIC MATERIAL COMPOSITES

Confirmation No.: 5990

Art Unit: 1714

Examiner: Not Yet Assigned

STATUS INQUIRY

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

It is respectfully requested that the attorney named below be advised of the status of the above-identified application. Please advise us of when we might expect to receive an Office Action from the Patent and Trademark Office.

November 3, 2004

Respectfully submitted,

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